

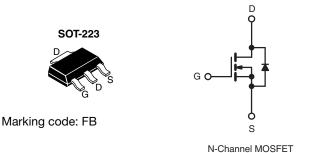
Vishay Siliconix

COMPLIANT

HALOGEN FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	100)
$R_{DS(on)}(\Omega)$	$V_{GS} = 10 \text{ V}$	0.54
Q _g (Max.) (nC)	8.3	
Q _{gs} (nC)	2.3	
Q _{gd} (nC)	3.8	
Configuration	Sing	le



FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION		
Package	SOT-223	SOT-223
Lead (Pb)-free and Halogen-free	SiHFL110-GE3	SiHFL110TR-GE3 ^a
Load (Dh) from	IRFL110PbF	IRFL110TRPbF ^a
Lead (Pb)-free	SiHFL110-E3	SiHFL110T-E3 a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T_C		1				
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	100	V		
Gate-Source Voltage		V_{GS}	± 20	V		
Continuous Drain Current	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	_	1.5		
Continuous Drain Current	VGS at 10 V	T _C = 100 °C	I _D	0.96	А	
Pulsed Drain Current ^a			I _{DM}	12		
Linear Derating Factor				0.025	W/°C	
Linear Derating Factor (PCB Mount) ^e	Derating Factor (PCB Mount) ^e 0.017		- W/ C			
Single Pulse Avalanche Energy b			E _{AS}	150	mJ	
Repetitive Avalanche Current ^a			I _{AR}	1.5	А	
Repetitive Avalanche Energy a			E _{AR}	0.31	mJ	
Maximum Power Dissipation	T _C =	T _C = 25 °C		3.1	W	
Maximum Power Dissipation (PCB Mount) e	T _A =	25 °C	P_D	2.0	VV	
Peak Diode Recovery dV/dt ^c		dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Rang	е		T _J , T _{stg}	-55 to +150	50	
Soldering Recommendations (Peak Temperature) d	ring Recommendations (Peak Temperature) d for 10 s		-	300	- °C	

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). $V_{DD}=25$ V, starting $T_J=25$ °C, L=25 mH, $R_g=25$ Ω , $I_{AS}=3.0$ A (see fig. 12). $I_{SD}\leq5.6$ A, dl/dt ≤75 A/ μ s, $V_{DD}\leq V_{DS}$, $T_J\leq150$ °C.

- 1.6 mm from case.
- When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RAT	INGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				L	L		1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.63	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	_	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 100 V, V _{GS} = 0 V , V _{GS} = 0 V, T _J = 125 °C	-	-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 0.90 A ^b	-	-	0.54	Ω
Forward Transconductance	9fs		= 50 V, I _D = 0.90 A	1.1	_	-	S
Dynamic				l.	l	<u> </u>	
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V}, \\ V_{DS} = 25 \text{ V}, \\ f = 1.0 \text{ MHz, see fig. 5}$		-	180	-	pF
Output Capacitance	C _{oss}			-	81	-	
Reverse Transfer Capacitance	C _{rss}			-	15	-	
Total Gate Charge	Qq			-	-	8.3	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 b	-	-	2.3	
Gate-Drain Charge	Q _{gd}	1	See lig. 0 and 13 s	=.	-	3.8	
Turn-On Delay Time	t _{d(on)}			-	6.9	-	
Rise Time	t _r	V _{DD} :	= 50 V, I _D = 5.6 A,	-	16	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 24 \Omega$, $R_D = 8.4 \Omega$, see fig. 10 b		-	15	-	ns
Fall Time	t _f	1		-	9.4	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")		-	4.0	-	-11
Internal Source Inductance	L _S	package and die contact	center of	-	6.0	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the		-	-	1.5	
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	12	A
Body Diode Voltage	V_{SD}	T _J = 25 °C	, I _S = 1.5 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 %C 1	E C A -11/-14 - 400 A / - b	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_J = 25 \text{ °C, I}_F$	= 5.6 A, dl/dt = 100 A/µs b	-	0.44	0.88	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	minated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

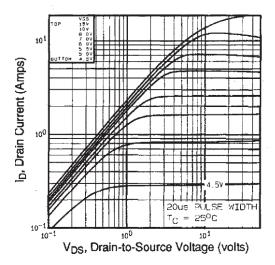


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

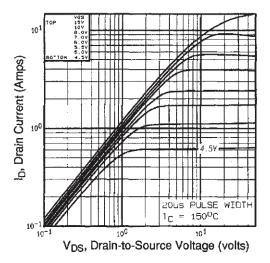


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

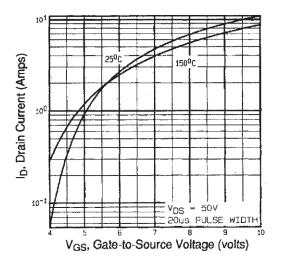


Fig. 3 - Typical Transfer Characteristics

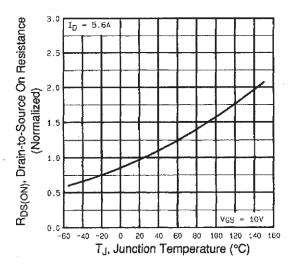


Fig. 4 - Normalized On-Resistance vs. Temperature



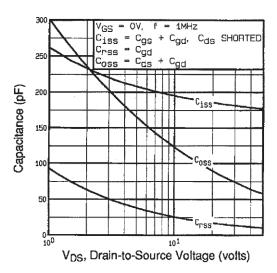


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

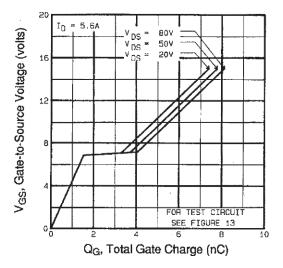


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

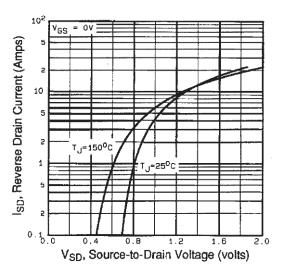


Fig. 7 - Typical Source-Drain Diode Forward Voltage

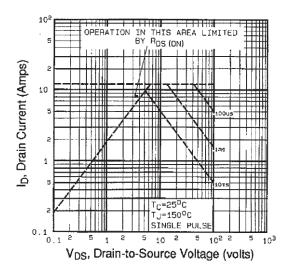


Fig. 8 - Maximum Safe Operating Area



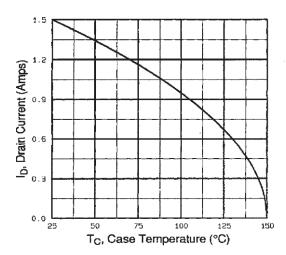


Fig. 9 - Maximum Drain Current vs. Case Temperature

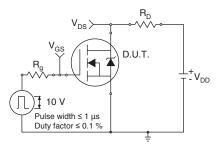


Fig. 10a -Switching Time Test Circuit

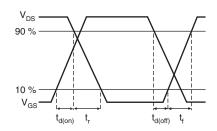


Fig. 10b - Switching Time Waveforms

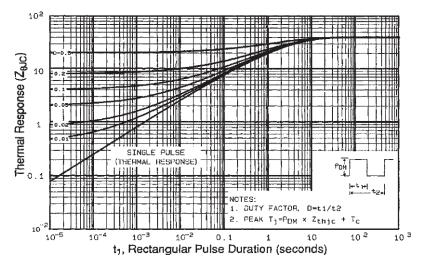


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



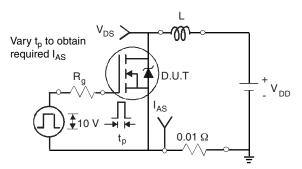


Fig. 12a - Unclamped Inductive Test Circuit

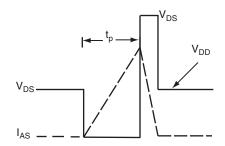


Fig. 12b - Unclamped Inductive Waveforms

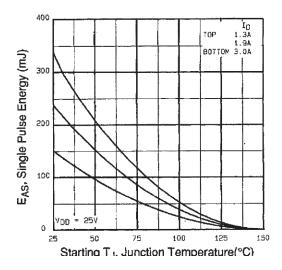


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

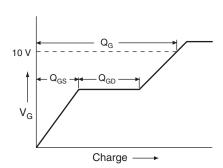


Fig. 13a - Basic Gate Charge Waveform

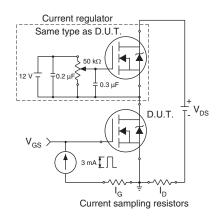
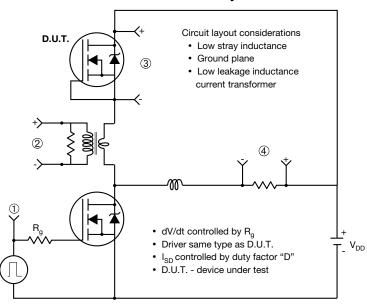


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



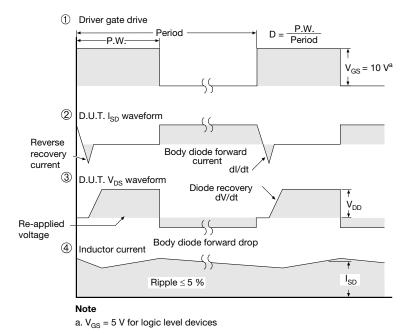


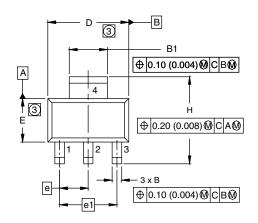
Fig.14 - For N-Channel

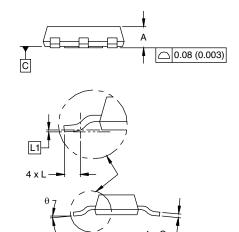
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SOT-223 (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30	2.30 BSC		5 BSC	
e1	4.60	BSC	0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	-	
L1	0.06	0.061 BSC		4 BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

Document Number: 91363 www.vishay.com
Revision: 15-Sep-08 1



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